February 1999 PRELIMINARY

FDD6680A

FAIRCHILD SEMICONDUCTOR

FDD6680A

N-Channel, Logic Level, PowerTrench[™] MOSFET

General Description

This N-Channel Logic level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

Applications

- DC/DC converter
- Motor drives

Features

- 56 A, 30 V. $R_{DS(ON)} = 0.0095 \ \Omega \ @ V_{GS} = 10 \ V$ $R_{DS(ON)} = 0.0130 \ \Omega \ @ V_{GS} = 4.5 \ V.$
- Low gate charge (23nC typical).
- Fast switching speed.
- High performance trench technology for extremely low $R_{\mbox{\tiny DS(ON)}}.$





Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	V
I _D	Maximum Drain Current - Continuous	(Note 1)	56	A
		(Note 1a)	14	
	Maximum Drain Current - Pulsed		100	
PD	Maximum Power Dissipation @ T _C = 25°C	(Note 1)	60	W
	$T_A = 25^{\circ}C$	(Note 1a)	2.8	
	$T_A = 25^{\circ}C$	(Note 1b)	1.3	
T _J , T _{stg}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	2.1	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDD6680A	FDD6680A	13"	16mm	2500

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	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	urce Avalanche Ratings (Note 1)				
N _{DSS}	Single Pulse Drain-Source Avalanche Energy	$V_{DD} = 15 \text{ V}, \text{ I}_{D} = 56 \text{ A}$			200	mJ
AR	Maximum Drain-Source Avalanche Cu	rrent			56	Α
Off Chara	acteristics					
3V _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	30			V
	Breakdown Voltage Temperature Coefficient	I_D =250µA,Referenced to 25°C		23		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 20 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
On Chara	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, \ I_{\text{D}} = 250 \ \mu\text{A}$	1	1.5	3	V
<u>ΔV_{GS(th)}</u> ΔT _J	Gate Threshold Voltage Temperature Coefficient	I_D =250µA,Referenced to 25°C		-4		mV/°C
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}, T_J = 125^{\circ}\text{C}$ $V_{GS} = 4.5 \text{ V}, I_D = 12 \text{ A}$		0.008 0.012 0.010	0.0095 0.0120 0.0130	Ω
D(on)	On-State Drain Current	$V_{GS} = 5 \text{ V}, V_{DS} = 5 \text{ V}$	50			Α
JFS	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 14 \text{ A}$		41		S
Dynamic	Characteristics					
	Input Capacitance	$V_{DS} = 15 V. V_{CS} = 0 V.$		2180		pF
- 135 Cocc	Output Capacitance	f = 1.0 MHz		500		pF
	Reverse Transfer Capacitance			255		pF
Switchin	a Characteristics where					
	Turn-On Delay Time	Vpp = 15 V. lp = 1 A.		13	24	ns
-d(01)	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		14	26	ns
d(off)	Turn-Off Delay Time			43	70	ns
(OII)	Turn-Off Fall Time			15	27	ns
<u>,</u>	Total Gate Charge	$V_{DS} = 15 V. I_{D} = 14 A.$		23	33	nC
	Gate-Source Charge	$V_{GS} = 5 V,$		7		nC
ys	Gate-Drain Charge			11		nC
2 _{ad}	5 m 2 m 5 m 9 m					
Q _{gd} Droin So	uras Diada Charastaristica a	nd Maximum Datinga				
ସ୍ତୁ Drain-So	urce Diode Characteristics a	nd Maximum Ratings	1		23	Δ

FDD6680A

FDD6680A, Rev. B2



FDD6680A, Rev. B2



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